



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of: **Kensaku SHINOZAKI**

Group Art Unit: **1753**

Application Number: **10/775,075**

Examiner: **Luan V. Van**

Filed: **February 11, 2004**

Confirmation Number: **3422**

For: **COPPER FOIL FOR HIGH FREQUENCY CIRCUIT AND METHOD  
OF PRODUCTION OF SAME**

Attorney Docket Number: **042100**

Customer Number: **38834**

**INFORMATION DISCLOSURE STATEMENT**  
**UNDER 37 C.F.R. §1.97(d)/(e)(1)**

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

August 15, 2006

Sir:

Applicant directs the attention of the Patent and Trademark Office to the documents listed on the attached PTO/SB/08. A copy of each non- U.S. document is attached.

This Information Disclosure Statement is being submitted after mailing of a final action, a Notice of Allowance, or an action that otherwise closes prosecution in the application, but before or concurrent with payment of the Issue Fee. A check is attached hereto which covers the \$180.00 fee set forth in 37 C.F.R. §1.17(p).

The undersigned hereby certifies that each item of information contained in the Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Information Disclosure Statement. A copy of the foreign communication citing the documents is attached.

Information Disclosure Statement under 1.97(d)  
Attorney Docket No. 042100  
Application No. 10/775,075

If there are any fees due in connection with the filing of this paper, please charge Deposit  
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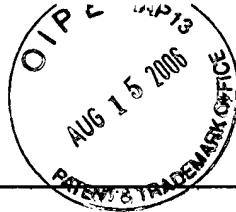
Respectfully submitted,  
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Enclosures: PTO/SB/08  
Foreign Communication  
4 Documents  
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|---|---|----|---|------------------------|-------------------|
| Combined Form PTO/SB/08A&B  |   |    |   | Complete if Known      |                   |
|   |   |    |   | Application Number     | 10/775,075        |
| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b><br><br>(use as many sheets as necessary) |   |    |   | Confirmation Number    | 3422              |
|   |   |    |   | Filing Date            | February 11, 2004 |
|   |   |    |   | First Named Inventor   | Kensaku SHINOZAKI |
|   |   |    |   | Art Unit               | 1753              |
|   |   |    |   | Examiner Name          | Luan V. Van       |
| Sheet   | 1 | of | 1 | Attorney Docket Number | 042100            |

| U.S. PATENT DOCUMENTS |                       |                 |                                      |                                |   |
|-----------------------|-----------------------|-----------------|--------------------------------------|--------------------------------|---|
| Examiner Initials*    | Cite No. <sup>1</sup> | Document Number |                                      | Publication Date<br>MM-DD-YYYY | Name of Patentee or Applicant of Cited Document |
|                       |                       | Number          | Kind Code <sup>2</sup><br>(if known) |                                |   |
|                       |                       | US              |                                      |                                |   |
|                       |                       | US              |                                      |                                |   |
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| FOREIGN PATENT DOCUMENTS |                       |                           |                     |                                      |                                |   |                          |
|--------------------------|-----------------------|---------------------------|---------------------|--------------------------------------|--------------------------------|---|--------------------------|
| Examiner Initials*       | Cite No. <sup>1</sup> | Foreign Patent Document   |                     |                                      | Publication Date<br>MM-DD-YYYY | Name of Patentee or Applicant of Cited Document | Translation <sup>6</sup> |
|                          |                       | Country Code <sup>3</sup> | Number <sup>4</sup> | Kind Code <sup>5</sup><br>(if known) |                                |   |                          |
|                          | 1                     | JP                        | 2002-322586         | A                                    | 11-8-2002                      | Furukawa Circuit Foil KK                        | Abstract                 |
|                          | 2                     | EP                        | 1 272 017           | A1                                   | 01-02-2003                     | Nikko Materials Company, Limited                | Yes                      |
|                          | 3                     | EP                        | 0 709 494           | A2 & A3                              | 05-01-1996                     | Circuit Foil Japan Co. Ltd.                     | Yes                      |
|                          | 4                     | EP                        | 1 182 278           | A2 & A3                              | 02-27-2002                     | Mitsui Mining & Smelting Co., Ltd.              | Yes                      |
|                          |                       |                           |                     |                                      |                                |   |                          |
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|                          |                       |                           |                     |                                      |                                |   |                          |

| NON PATENT LITERATURE DOCUMENTS |                       |  |                          |
|---------------------------------|-----------------------|--|--------------------------|
| Examiner Initials*              | Cite No. <sup>1</sup> | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published. | Translation <sup>6</sup> |
|                                 | 5                     | EP 04 00 3195 Search Report dated June 14, 2006.   | Yes                      |
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| Examiner Signature |  | Date Considered |  |
|--------------------|--|-----------------|--|

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup>Applicant's unique citation designation number (optional). <sup>2</sup>See Kind Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov), MPEP 901.04 or in the comment box of this document. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to indicate here if English language Translation is attached.